Document Number: STCV10600RBY4
Preliminary Datasheet V1.1

Gallium Nitride 50V, 600W,0.6-1GHz RF Power Transistor Description

The STCV10600RBY4 is a 600watt Doherty pair capable, GaN HEMT, ideal for for 4G/5G cellular applications up to 1GHz.

It can be configured as asymmetrical Doherty delivering 80-100W average power, according to normal 8-9dB back off.

There is no guarantee of performance when this part is used outside of stated frequencies.

• Typical RF performance on 578-678MHz Doherty

VDD = 50 Vdc, IDQ_main = 100mA, Vgs peak=-4.9V, 1 carrier WCDMA signal PAR=10.5dB

	,		9	,		3	
Freq	Pout	CCDF	Ppeak	Ppeak	ACPR	Gain	Eff
(MHz)	(dBm)	(dB)	(dBm)	(W)	(dBc)	(dB)	(%)
578	50	7.91	57.94	623.0	-28.6	17.3	61.5
628	50	7.70	57.70	589.2	-30.0	17.8	60.0
678	50	8.08	58.07	641.9	-31.8	16.9	60.1

Applications

- Asymmetrical Doherty amplifier within <1GHz
- UHF TV
- P band communication

Important Note: Proper Biasing Sequence for GaN HEMT Transistors

Turning the device ON

- 1. Set VGS to the pinch--off (VP) voltage, typically -5 V
- 2. Turn on VDS to nominal supply voltage
- 3. Increase VGS until IDS current is attained
- 4. Apply RF input power to desired level

Turning the device OFF

- 1. Turn RF power off
- 2. Reduce VGS down to VP, typically -5 V
- 3. Reduce VDS down to 0 V
- 4. Turn off VGS

Figure 1: Pin Connection definition

Transparent top view (Backside grounding for source)

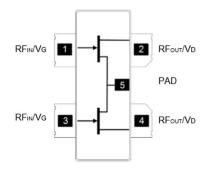


Table 1. Maximum Ratings

Rating	Symbol	Value	Unit
DrainSource Voltage	V _{DSS}	+200	Vdc
GateSource Voltage	V_{GS}	-8 to +0.5	Vdc
Operating Voltage	V_{DD}	55	Vdc







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Maximum gate current	lgs	82	mA
Storage Temperature Range	Tstg	-65 to +150	٥°
Case Operating Temperature	Tc	+150	°C
Operating Junction Temperature	TJ	+225	°C

Table 2. Thermal Characteristics

Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction to Case by FEA	Paus	1.5	0C AM
T _C = 85°C, at Pd=60W, on Doherty application board	Rejc	1.5	°C /W

Table 3. Ruggedness Characteristics

Characteristic	Conditions	Symbol	Min	Тур	Max	Unit
Load mismatch capability	700MHz, Pout=100W pulse CW					
	for All phase,	VSWR		10:1		
	No device damages					

Figure 2: Median Lifetime vs. Channel Temperature

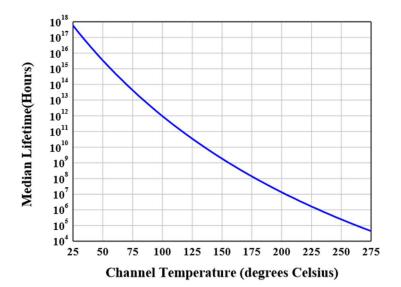




Figure 3: Efficiency and power gain as function of Pout (578-678MHz Doherty)

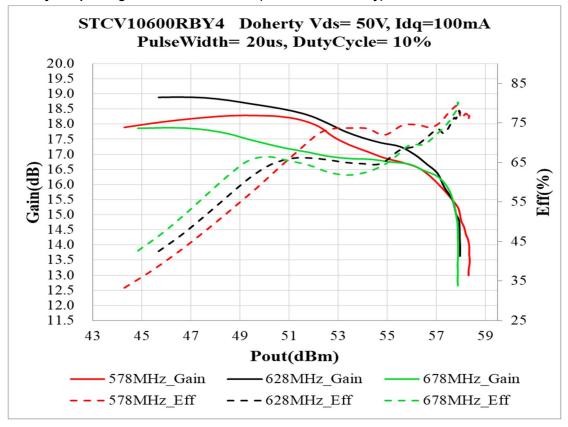
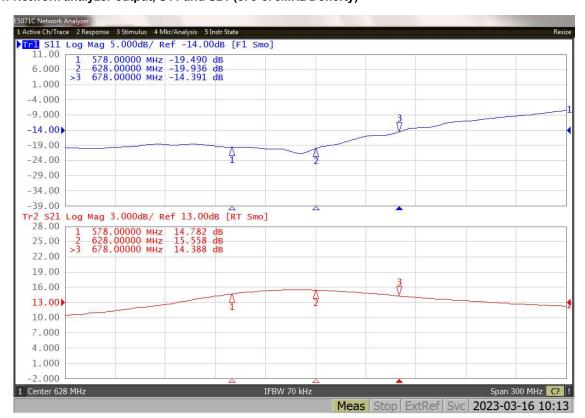


Figure 4: Network analyzer output, S11 and S21 (578-678MHz Doherty)



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Figure 5: Picture of application board Doherty circuit for 578-678MHz

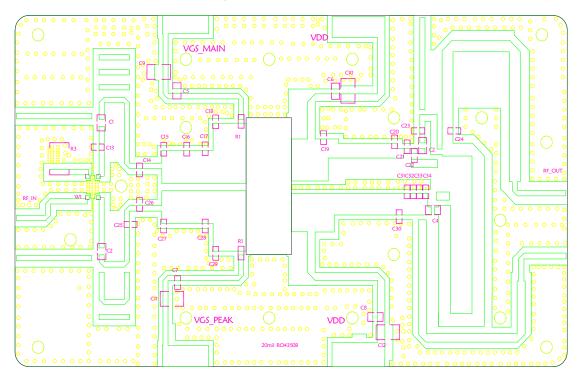


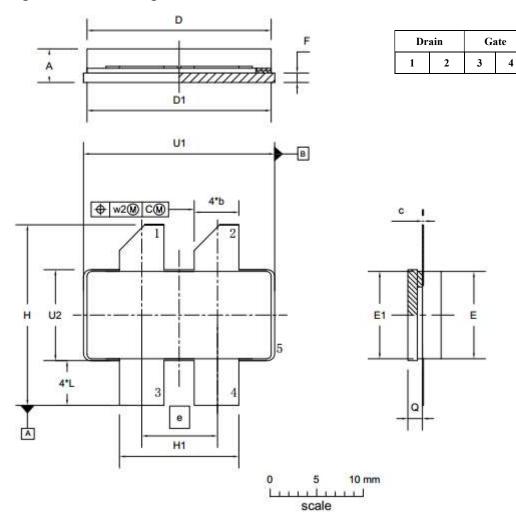
Table 4. Bill of materials of application board (PCB layout upon request, RO4350B 30mils)

Designator	Footprint	Description	Manufacture	Quantity
C1, C2, C3, C4, C5, C6, C7, C8	0603/0805	100pF High Q Capacitor	TEMEX/ATC	8
C9, C10, C11, C12	1210	100uF/100V	Maruata	4
C13, C19, C23, C32	0603/0805	2.0pF High Q Capacitor	TEMEX/ATC	4
C14, C15, C17, C18, C25, C27, C28, C29	0603/0805	10pF High Q Capacitor	TEMEX/ATC	8
C16, C21, C22, C33, C34	0603/0805	6.8pF High Q Capacitor	TEMEX/ATC	5
C26	0603/0805	2.2 pF High Q Capacitor	TEMEX/ATC	1
C20, C24	0603/0805	1.0 pF High Q Capacitor	TEMEX/ATC	2
C30, C31	0603/0805	3.3 pF High Q Capacitor	TEMEX/ATC	2
R1,R2	0603	10Ω		2
R3	2512	51 Ω power resistor		1
W1		2 dB Bridge X3C07F1-02S	Anaren	1

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Source 5

Earless Flanged Ceramic Package; 4 leads



UNIT	A	b	С	D	D ₁	е	E	E ₁	F	н	H1	L	Q	U ₁	U ₂	W ₁	W ₂
	4.72	4.67	0.15	20.02	19.96	7.00	9.50	9.53	1.14	19.94	12.98	5.33	1.70	20.70	9.91	0.05	0.54
mm	3.43	4.93	0.08	19.61	19.66	7.90	9.30	9.25	0.89	18.92	12.73	4.32	1.45	20.45	9.65	0.25	0.51
inahaa	0.186	0.194	0.006	0.788	0.786	0.244	0.374	0.375	0.045	0.785	0.511	0.210	0.067	0.815	0.390	0.01	0.02
inches	0.135	0.184	0.003	0.772	0.774	0.311	0.366	0.364	0.035	0.745	0.501	0.170	0.057	0.805	0.380	0.01	0.02

OUTLINE		REFERENCE	EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	JEITA	PROJECTION	1000E DATE
PKG-B4					03/12/2013



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Revision history

Table 4. Document revision history

Date	Revision	Datasheet Status
2023/3/16	V1.0	Preliminary Datasheet Creation
2023/6/9	V1.1	Combined version to support 1GHz

Application data based on:LSM-23-10

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